



QPA0812

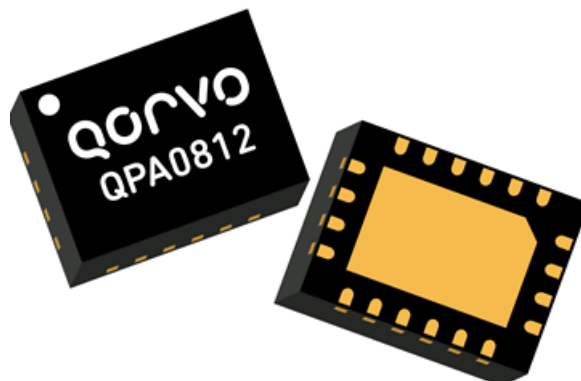
1 Watt X-Band Power Amplifier

Product Overview

Qorvo's QPA0812 is a packaged, high performance power amplifier fabricated on Qorvo's production QPHT15 (0.15um) pHEMT process. Covering 8.5 - 10.5 GHz, the QPA0812 provides > 1 W of saturated output power and 24 dB of large-signal gain while achieving 48% power-added efficiency.

Packaged in a small 4 x 3 mm plastic overmold QFN, tight lattice spacing requirements for phased array radar applications is easily supported. RF input and output ports are matched to 50Ω and include integrated DC blocking capacitors.

Lead-free and RoHS compliant.

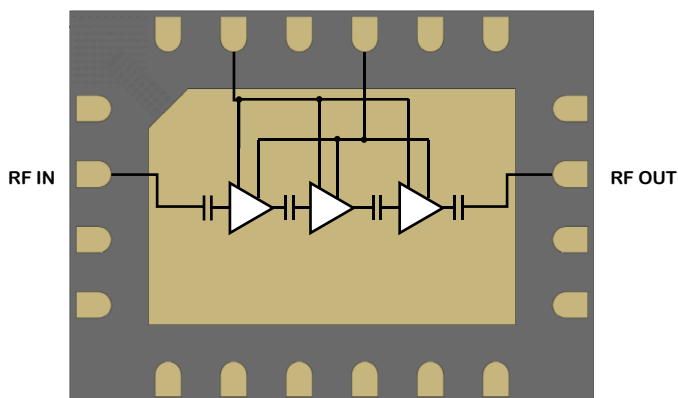


4 mm x 3 mm plastic overmold QFN

Key Features

- Frequency Range: 8.5 – 10.5 GHz
- Output Power ($P_{IN} = 6$ dBm): 30.8 dBm
- PAE ($P_{IN} = 6$ dBm): 48.2 %
- Small Signal Gain: 34.4 dB
- Recommended Bias: $V_D = 6$ V, $I_{DQ} = 156$ mA
- Package Size: 4.0 mm x 3.0 mm x 0.85 mm

Functional Block Diagram



Top View

Applications

- Radar
- Electronic Warfare

Ordering Information

Part No.	Description
QPA0812	1 Watt X-Band Power Amplifier
QPA0812TR7	500 pcs. on 7 inch reel
QPA0812EVB	QPA0812 Evaluation Board

Absolute Maximum Ratings

Parameter	Rating
Drain Voltage (V_D)	6.5 V
Gate Voltage Range (V_G)	-5 to 0 V
Drain Current (I_D)	635 mA
Gate Current (I_G)	10 mA
Power Dissipation (P_{DISS}), CW, $T_{BASE} = 85^\circ\text{C}$	1.37 W
Input Power (P_{IN}), Pulsed (100us/10%), 50 Ω , $V_D = 6\text{ V}$, $T_{BASE} = 85^\circ\text{C}$	16 dBm
Input Power (P_{IN}), Pulsed (100us/10%), VSWR 3:1, $V_D = 6\text{ V}$, $T_{BASE} = 85^\circ\text{C}$	16 dBm
Mounting Temperature (30 seconds max.)	260 $^\circ\text{C}$
Storage Temperature	-55 to 150 $^\circ\text{C}$

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Typ
Drain Voltage (V_D)	6 V
Drain Current (I_{DQ})	156 mA
Drain Current Under RF Drive (I_{D_DRIVE})	See plots pp. 3, 5-11

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

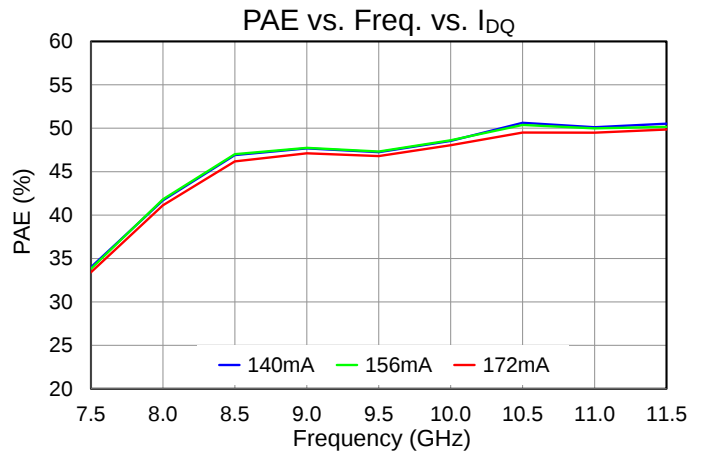
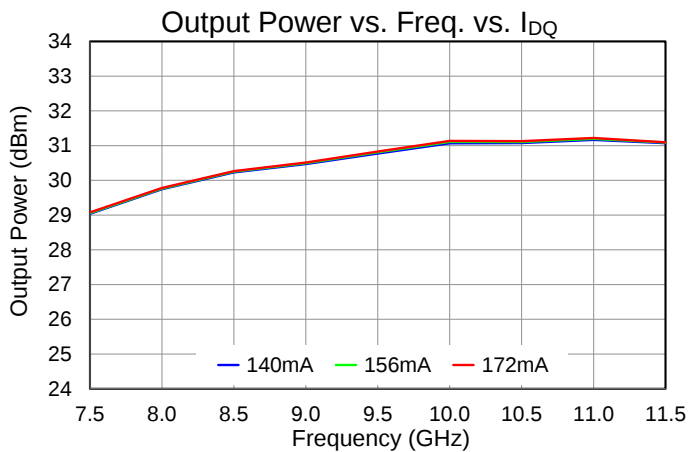
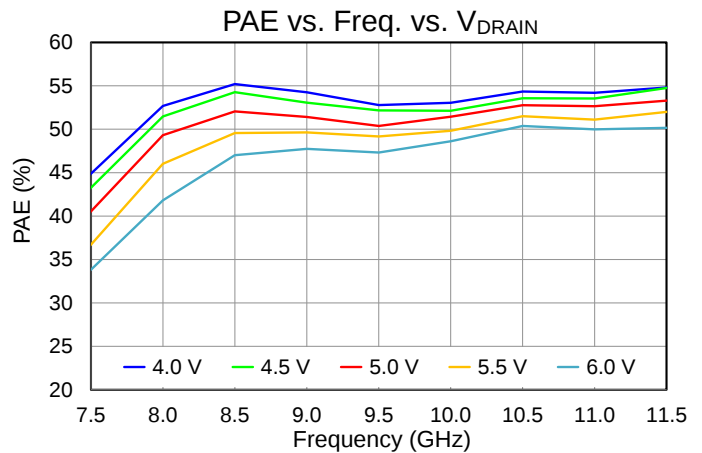
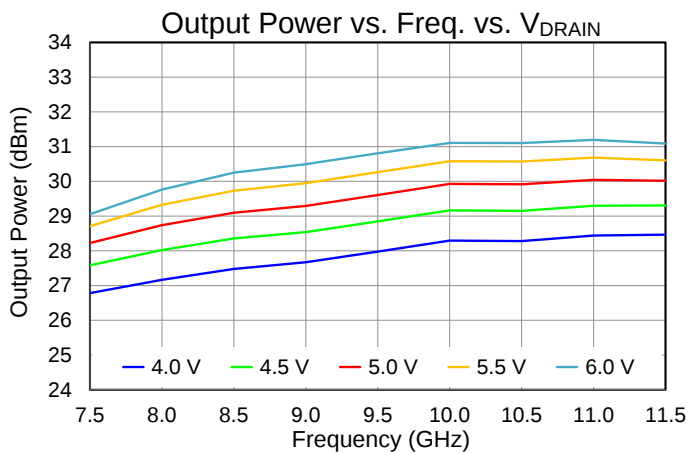
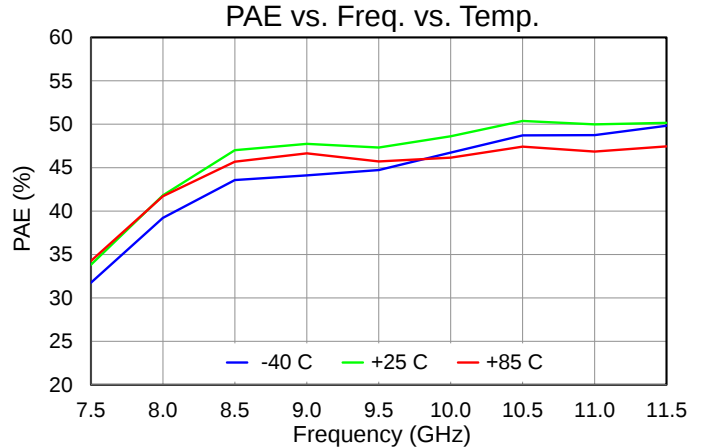
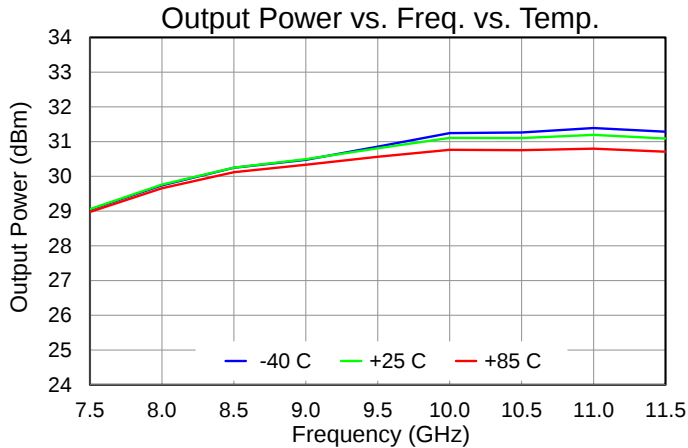
Electrical Specifications

Parameter	Conditions	Min	Typ	Max	Units
Operational Frequency		8.5		10.5	GHz
Output Power ($P_{IN} = 6\text{ dBm}$)	Pulsed V_D		30.8		dBm
Power Added Efficiency ($P_{IN} = 6\text{ dBm}$)	Pulsed V_D		48.2		%
Small Signal Gain (CW)			34.4		dB
Input Return Loss (CW)			17		dB
Output Return Loss (CW)			9		dB
2 ND Harmonic ($P_{IN} = 6\text{ dBm}$)	Pulsed V_D		-35		dBc
3 RD Harmonic ($P_{IN} = 6\text{ dBm}$)	Pulsed V_D		-36		dBc
P_{OUT} Temp. Coeff. (85 $^\circ\text{C}$ to -40 $^\circ\text{C}$, $P_{IN} = 6\text{ dBm}$)	Pulsed V_D		-0.002		dB/ $^\circ\text{C}$
Sm. Sig. Gain Temp. Coefficient (85 $^\circ\text{C}$ to -40 $^\circ\text{C}$)			-0.023		dB/ $^\circ\text{C}$
Gate Leakage Current	$V_D = 6\text{ V}$, $V_G = -3.3\text{ V}$	-1		1	mA

Test conditions, unless otherwise noted: $T = +25^\circ\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 us, Duty Cycle = 10%

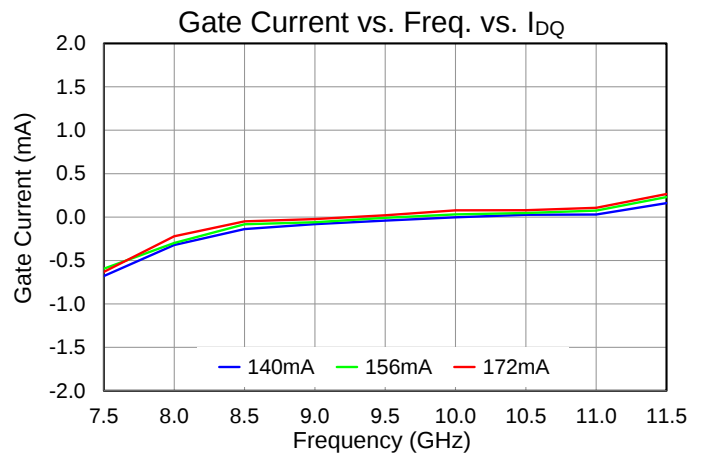
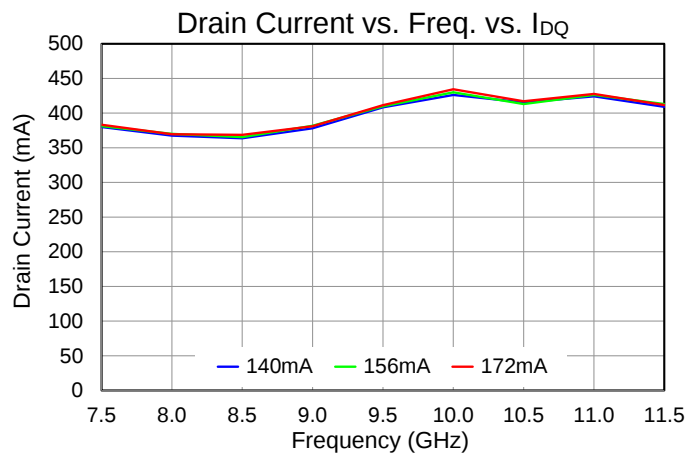
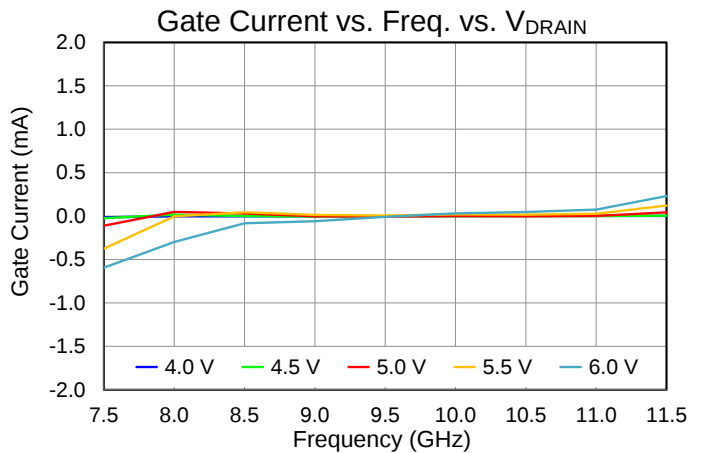
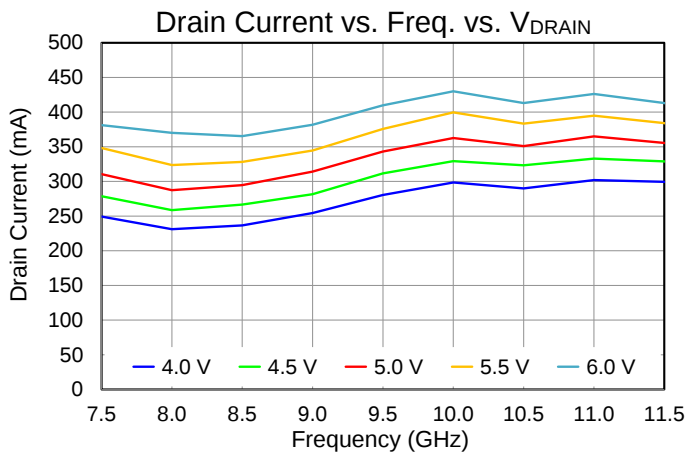
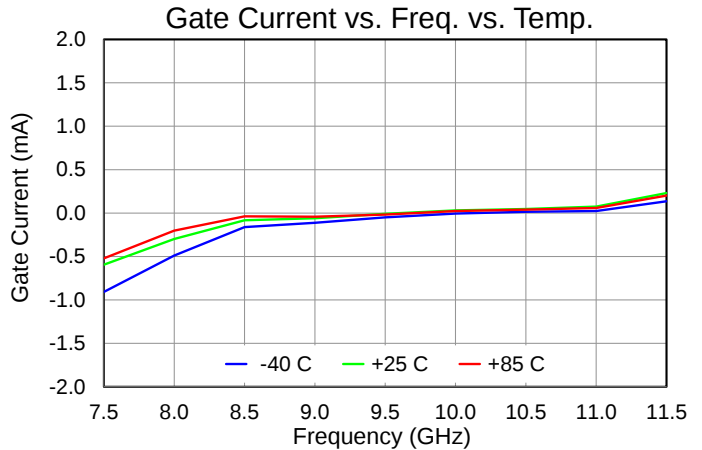
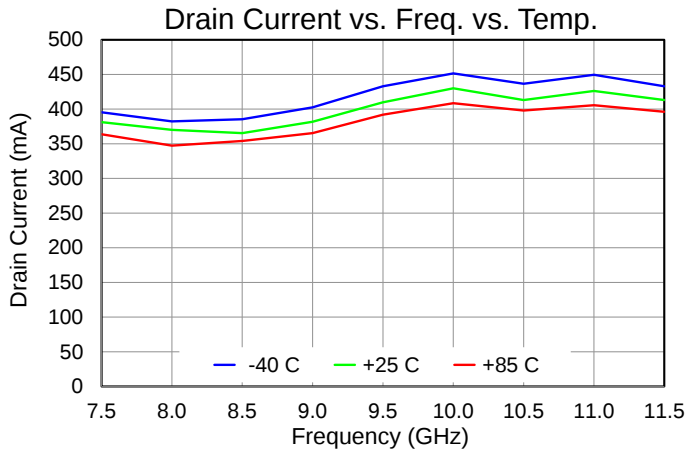
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, $P_{IN} = 6\text{ dBm}$, Pulse Width = 100 μs , Duty Cycle = 10%



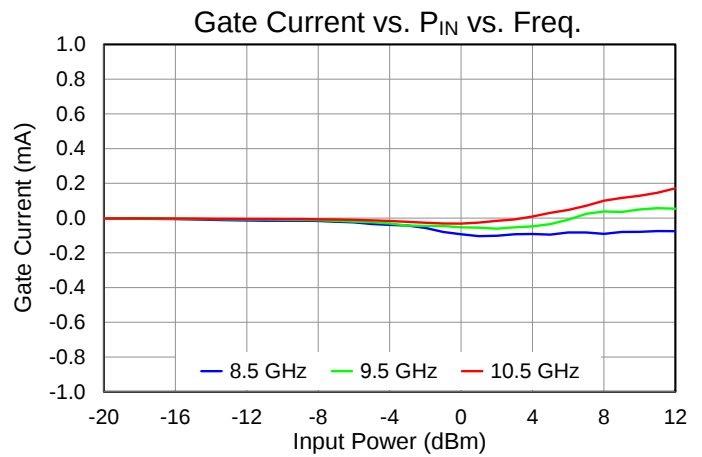
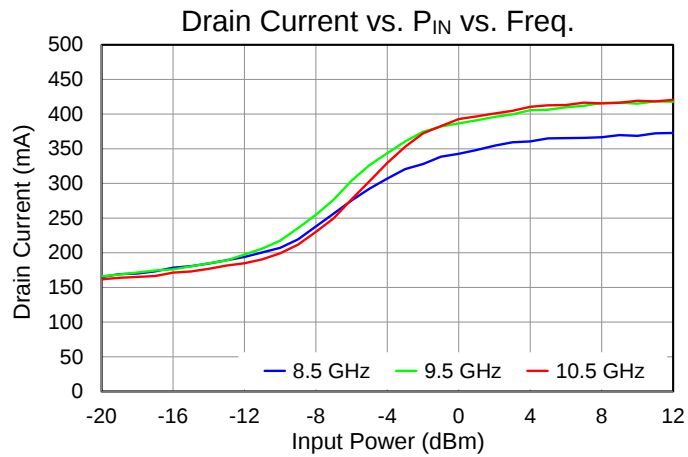
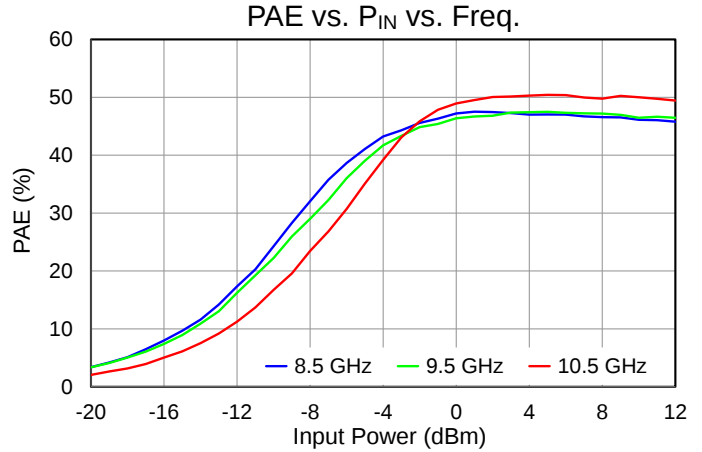
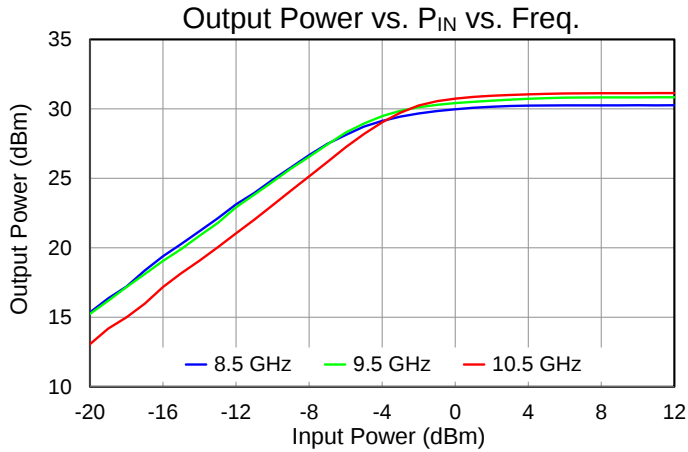
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, $P_{IN} = 6\text{ dBm}$, Pulse Width = 100 μs , Duty Cycle = 10%



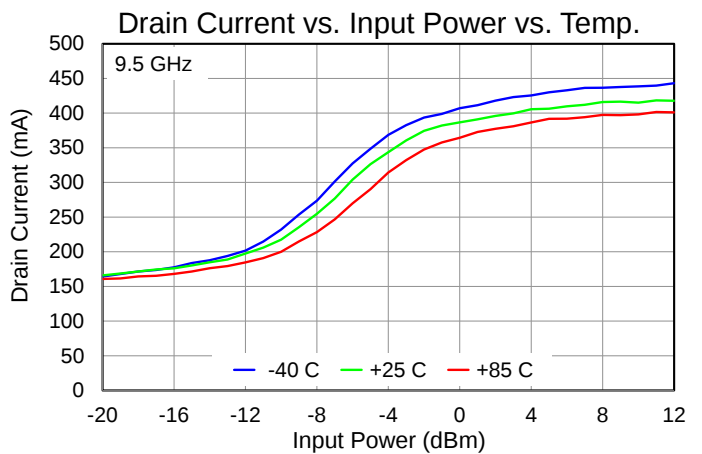
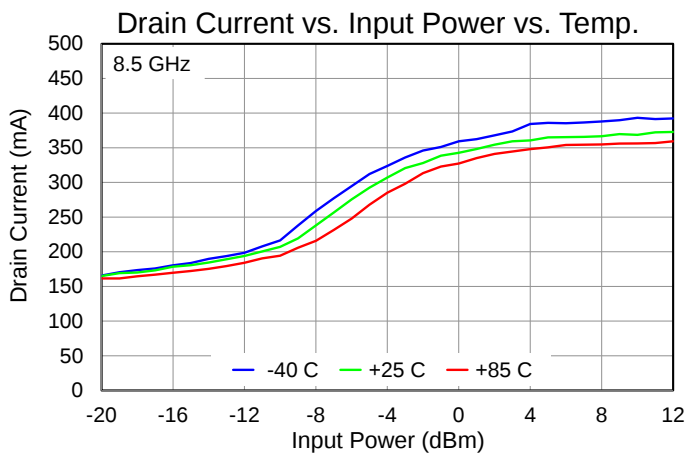
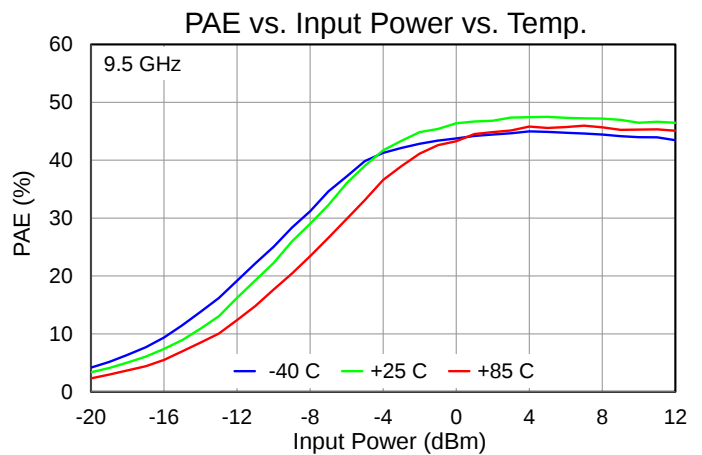
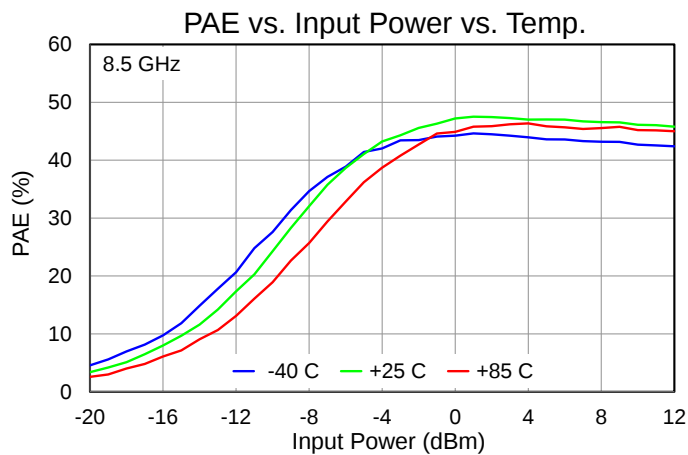
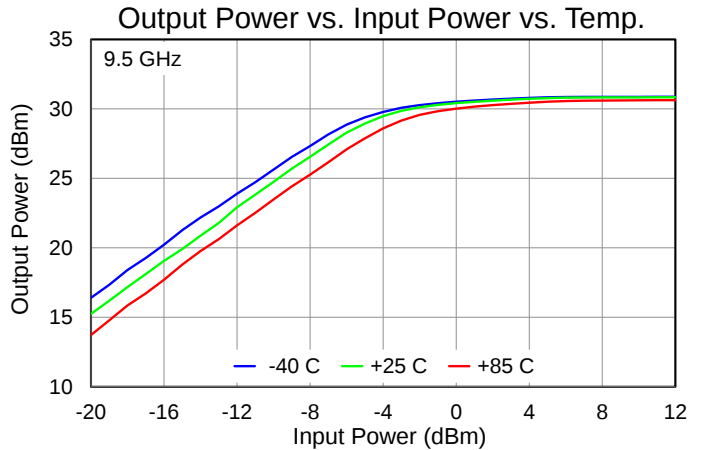
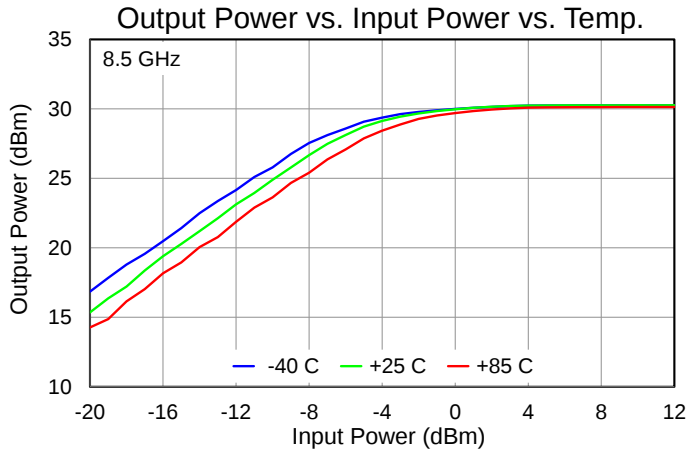
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



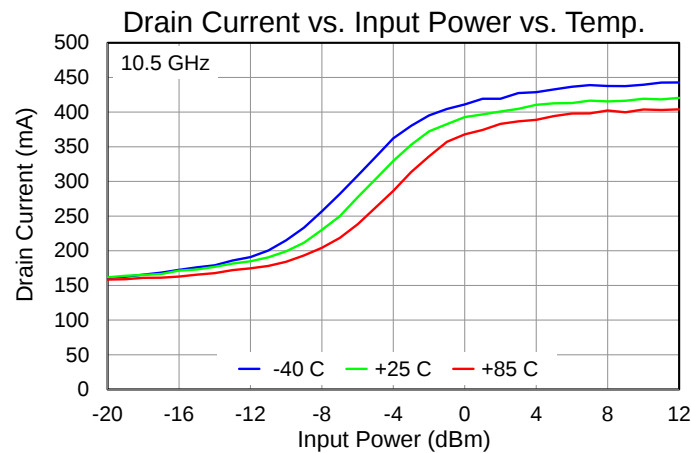
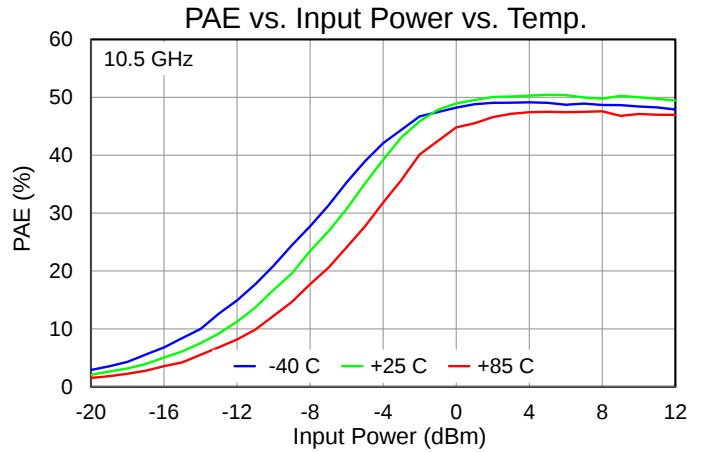
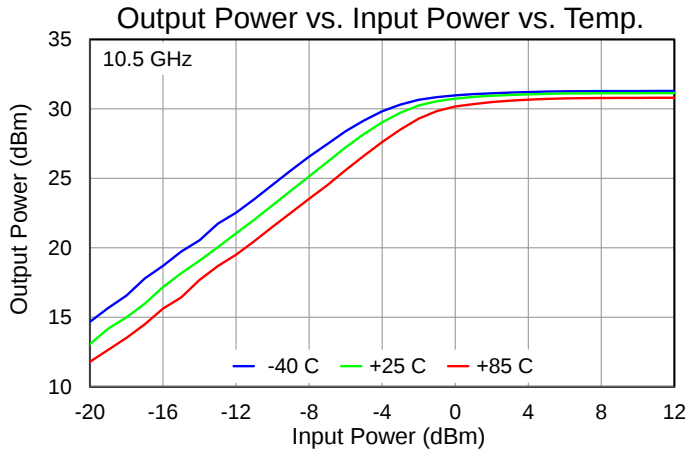
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: T = +25 °C, VD = 6 V, IDQ = 156 mA, Pulse Width = 100 us, Duty Cycle = 10%



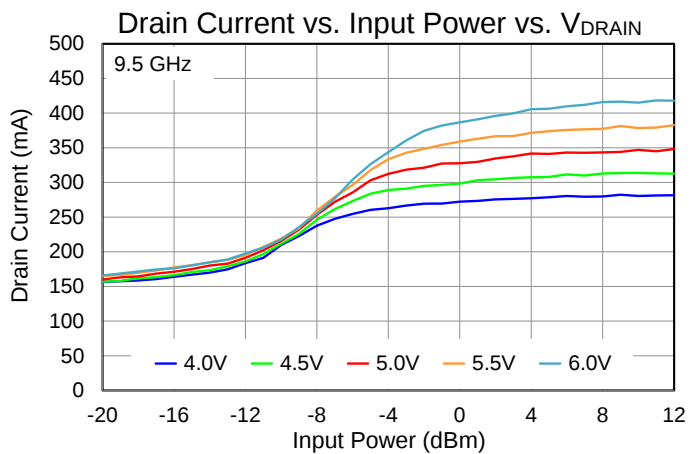
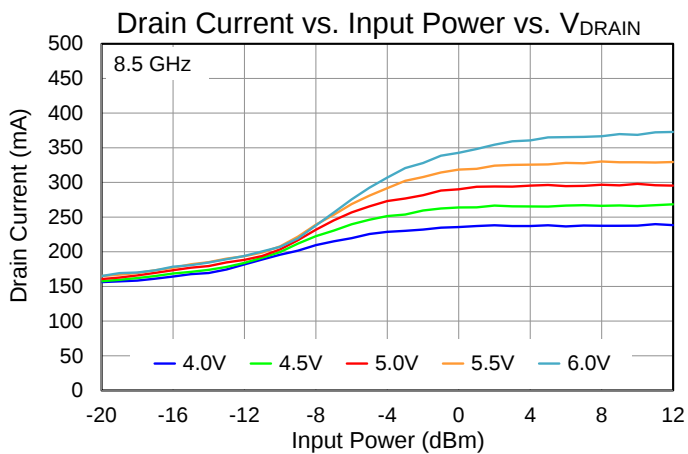
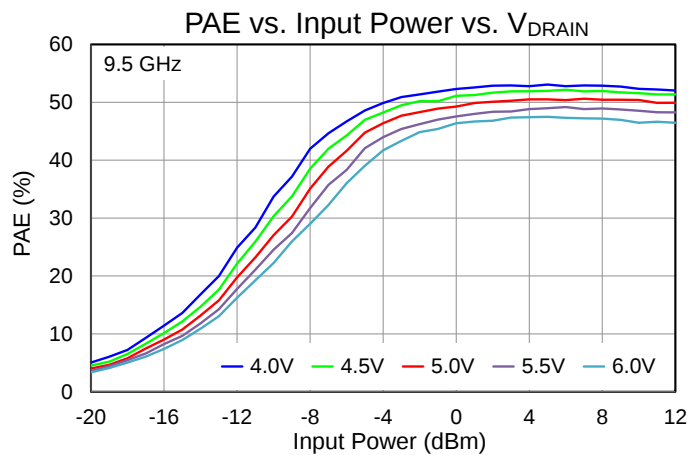
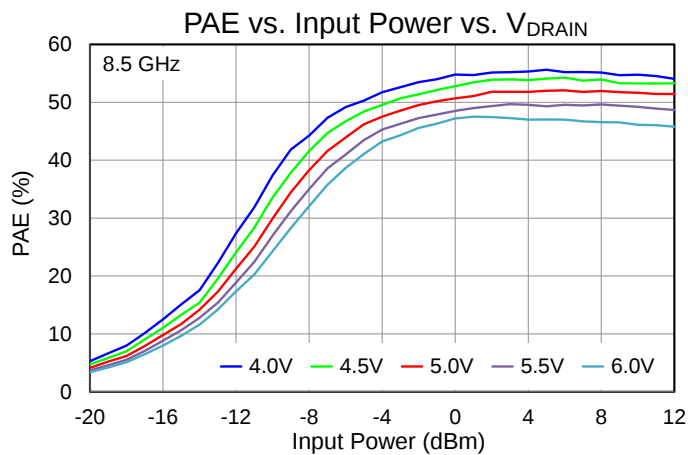
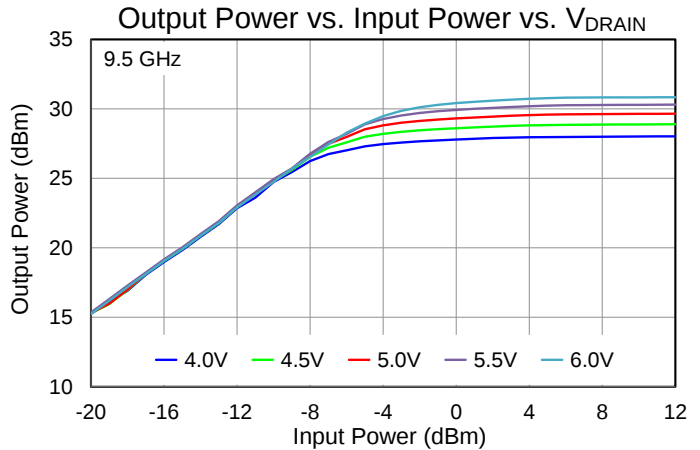
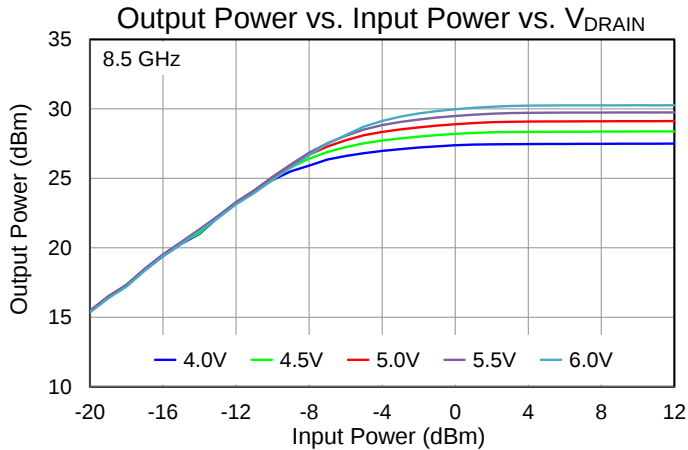
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: T = +25 °C, VD = 6 V, IDQ = 156 mA, Pulse Width = 100 us, Duty Cycle = 10%



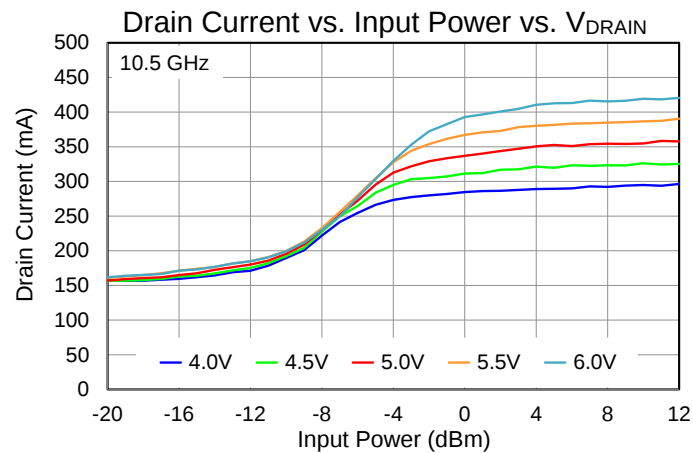
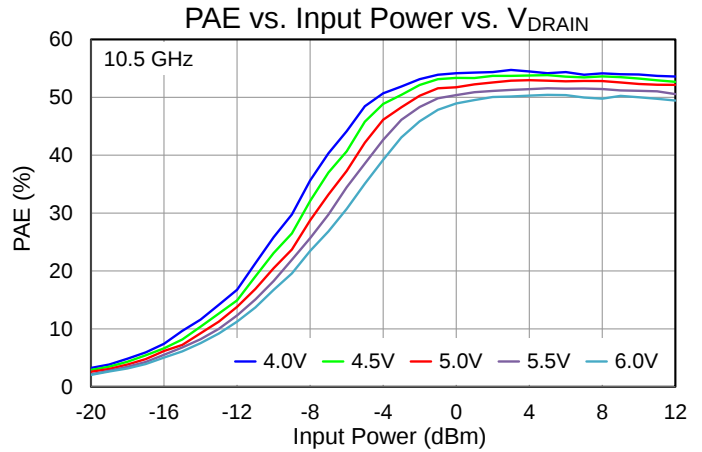
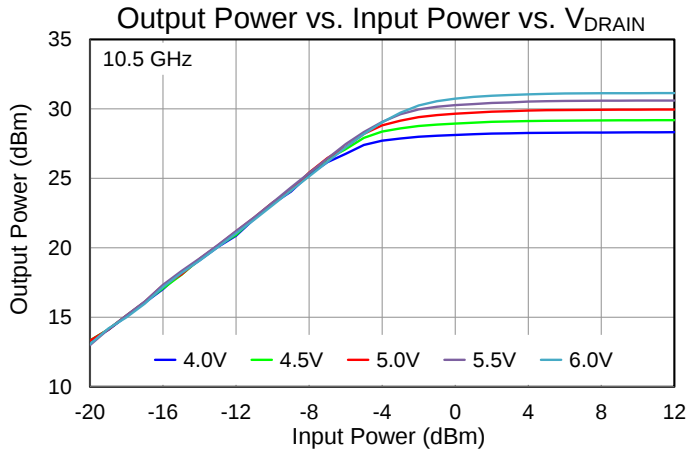
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



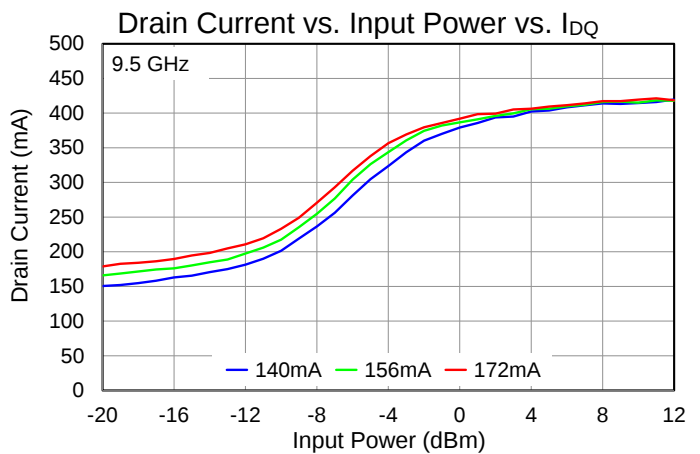
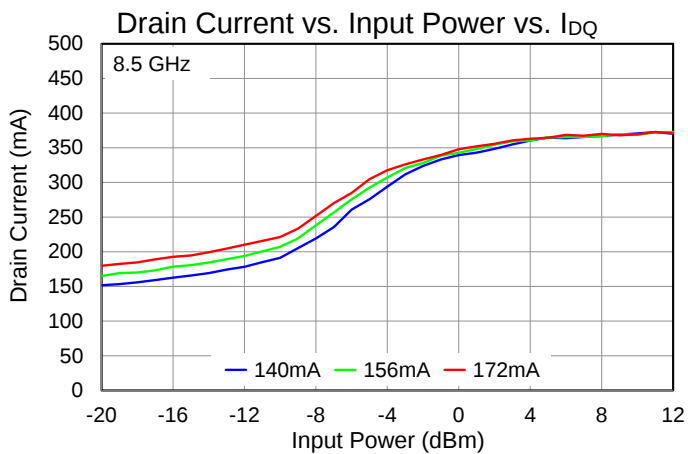
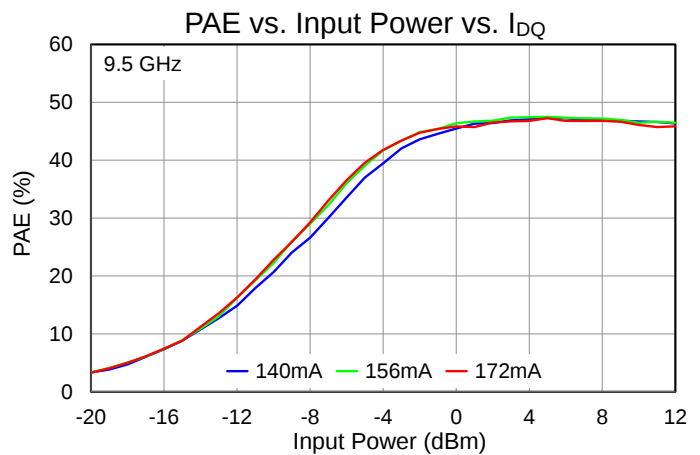
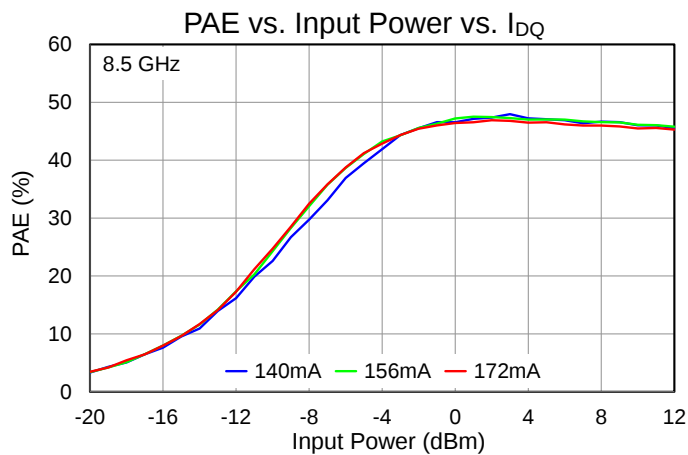
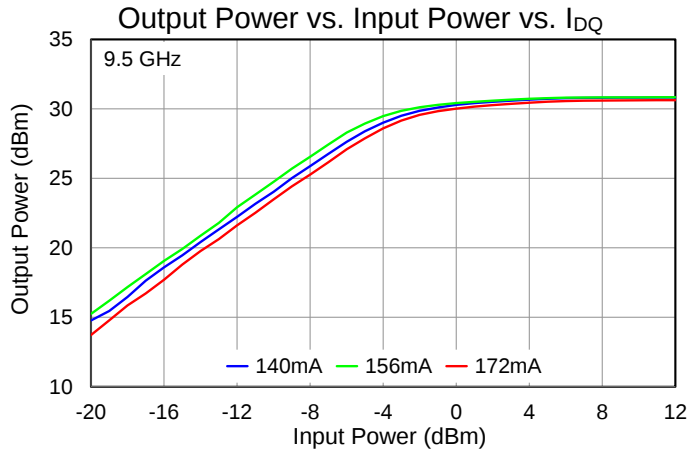
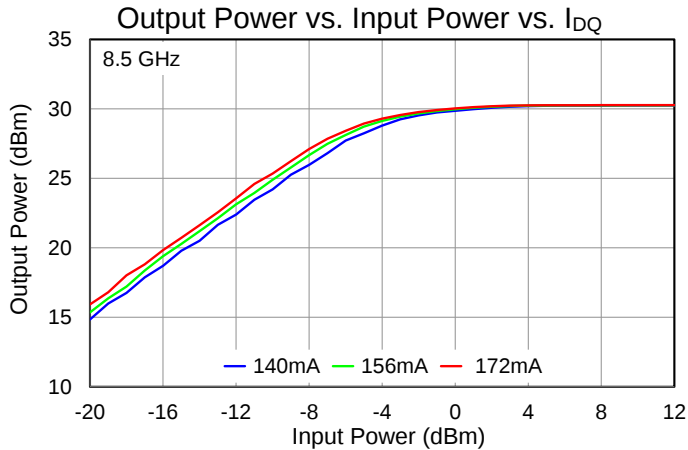
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



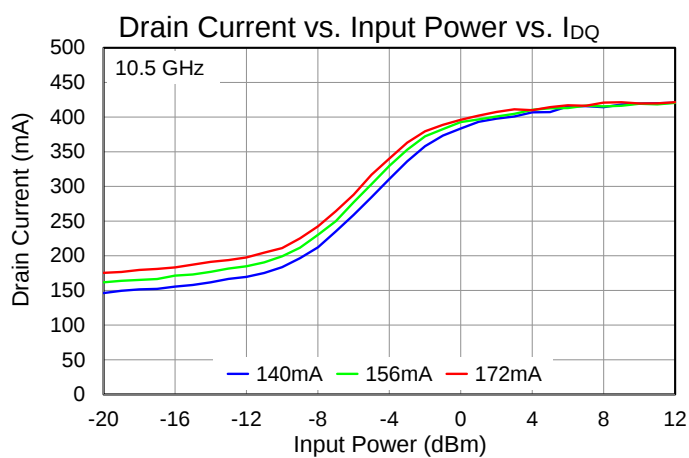
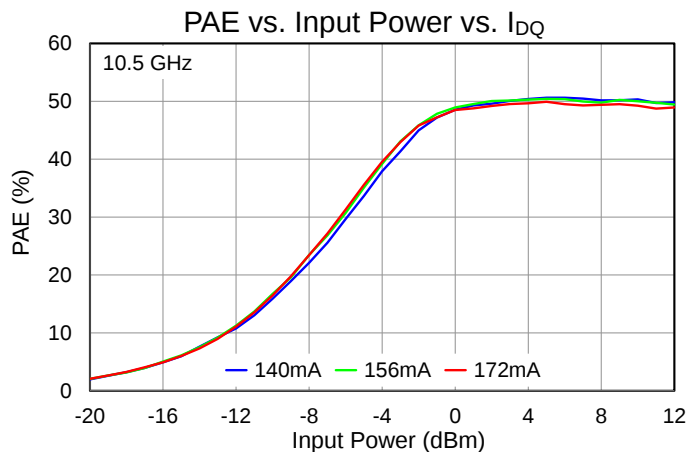
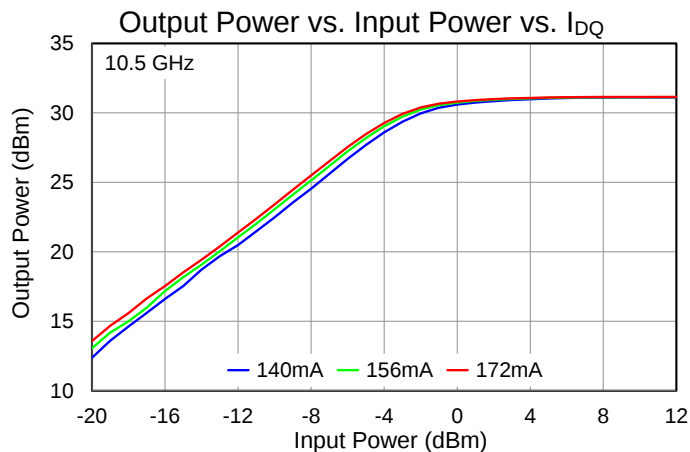
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



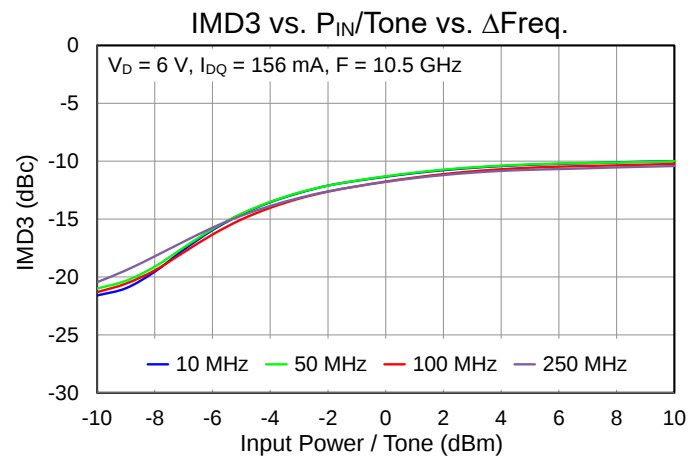
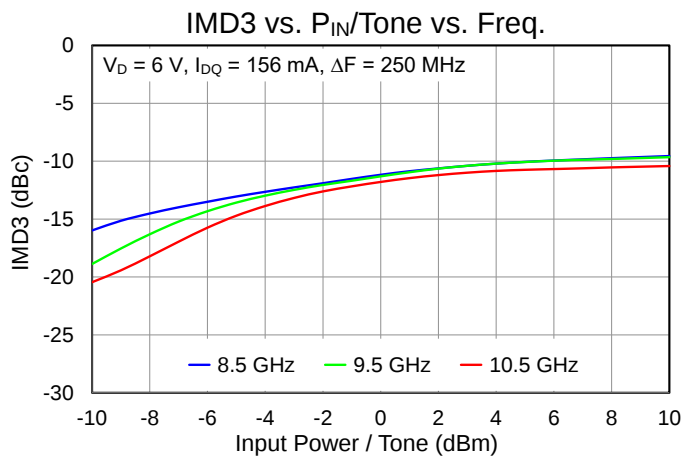
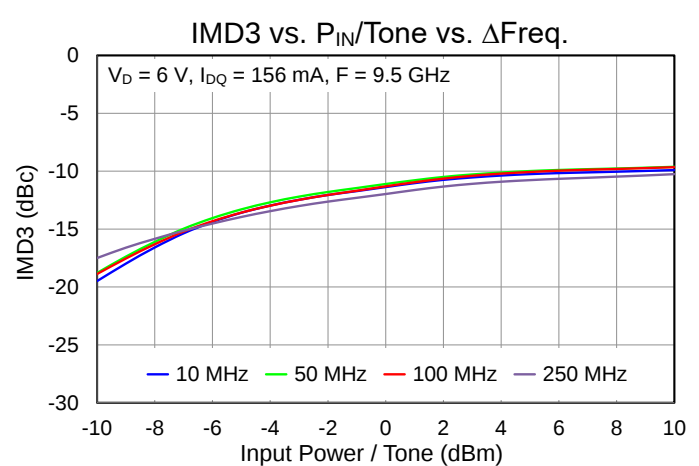
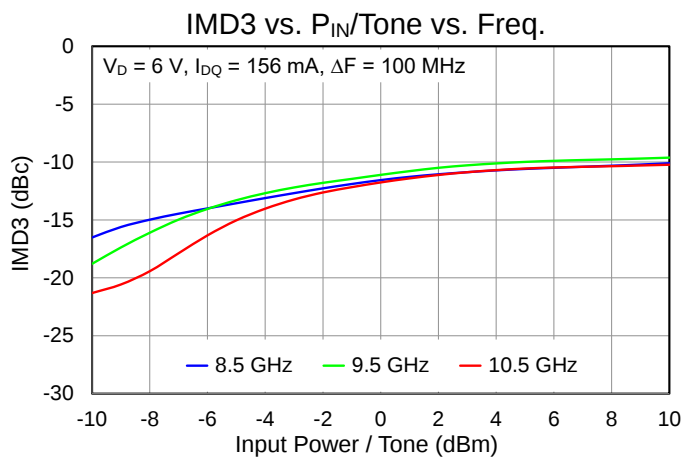
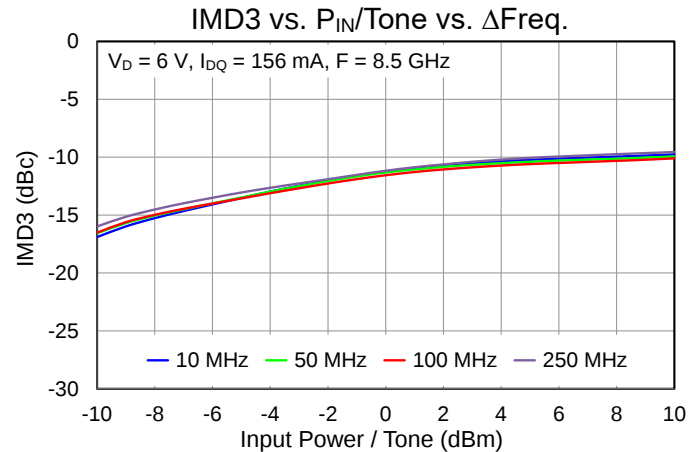
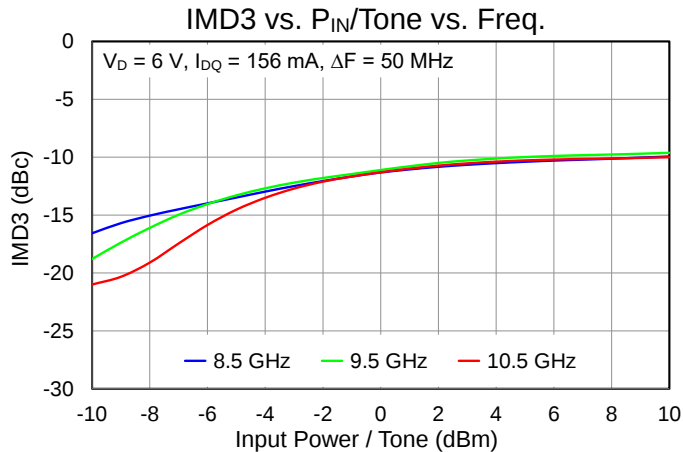
Performance Plots – Large Signal (Pulsed)

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



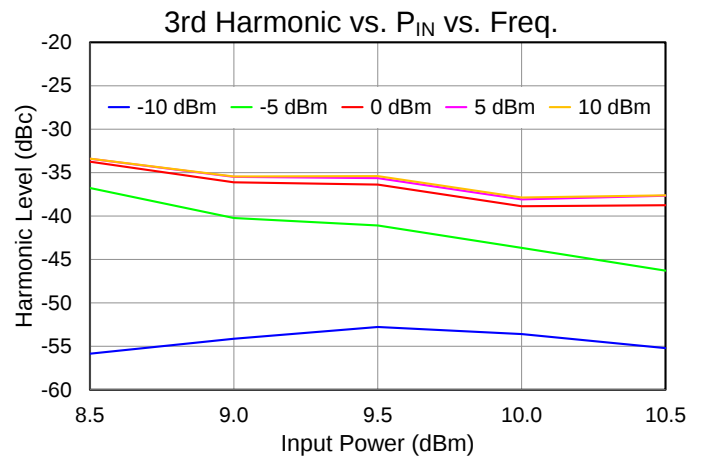
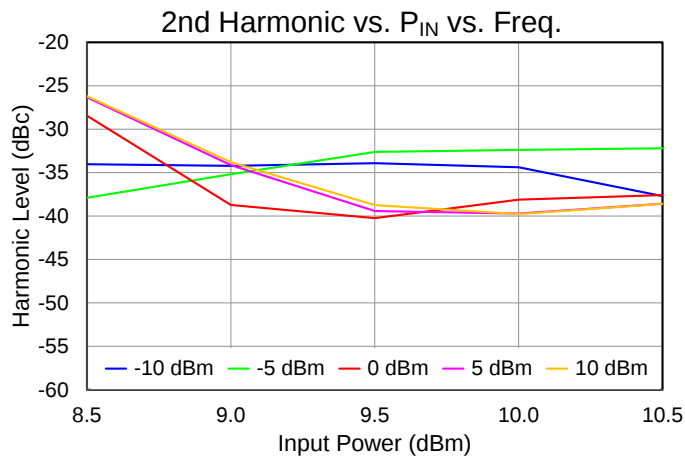
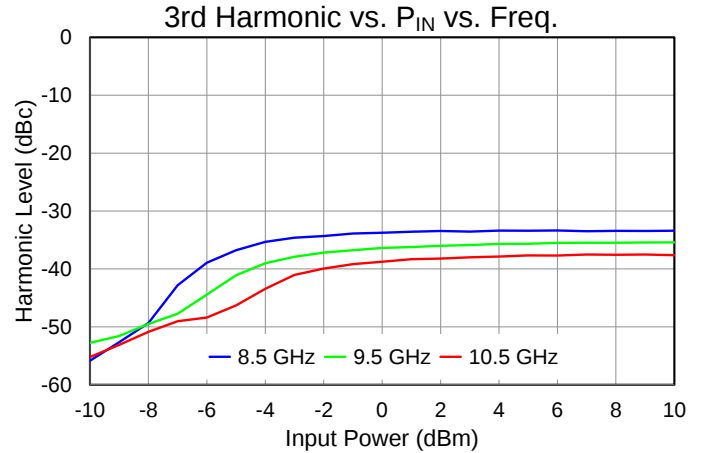
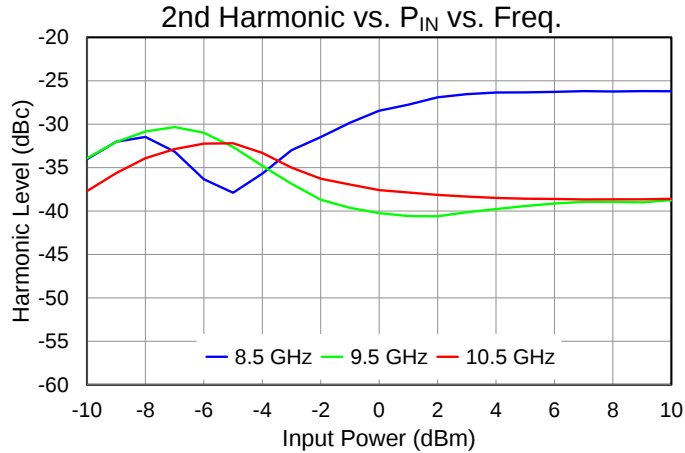
Performance Plots – Linearity

Test conditions unless otherwise noted: $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, $T = 25\text{ }^\circ\text{C}$, CW



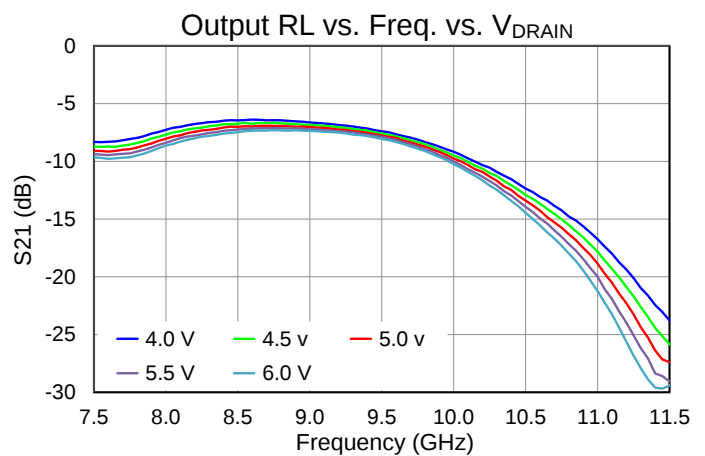
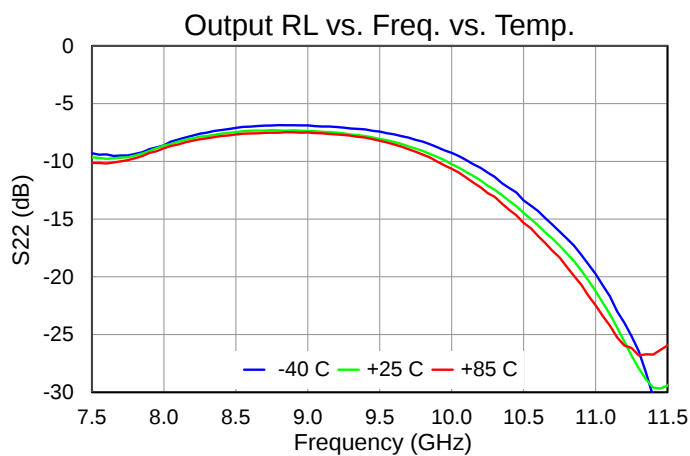
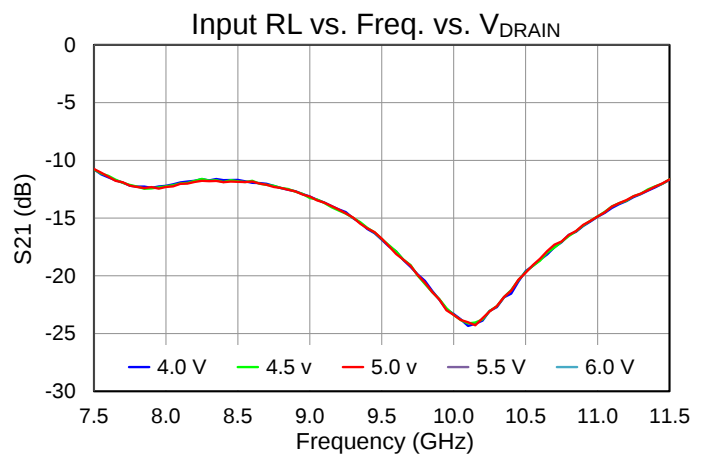
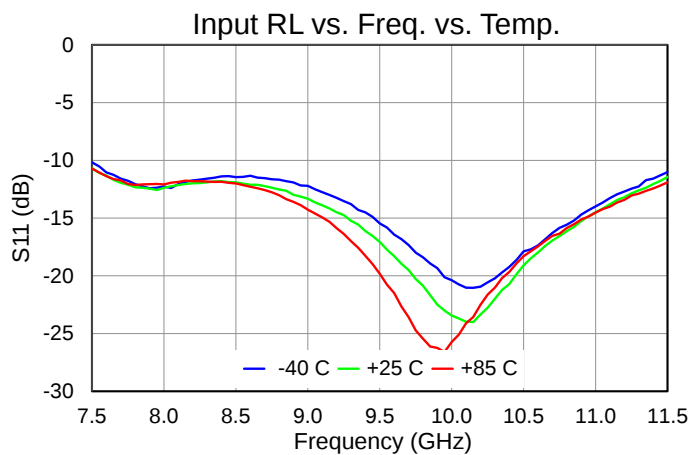
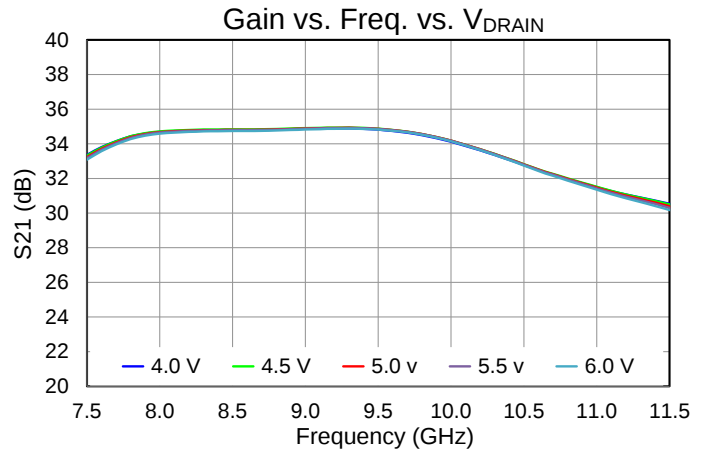
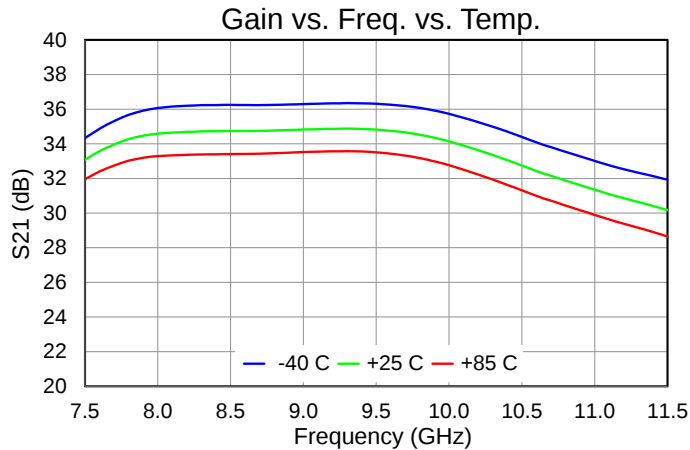
Performance Plots – Harmonics

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, Pulse Width = 100 μs , Duty Cycle = 10%



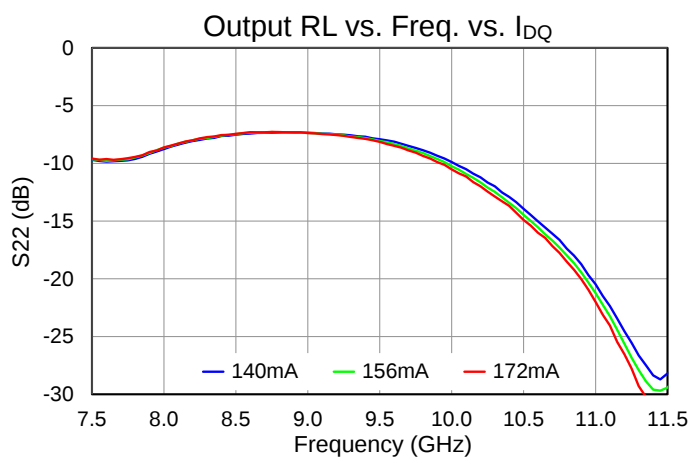
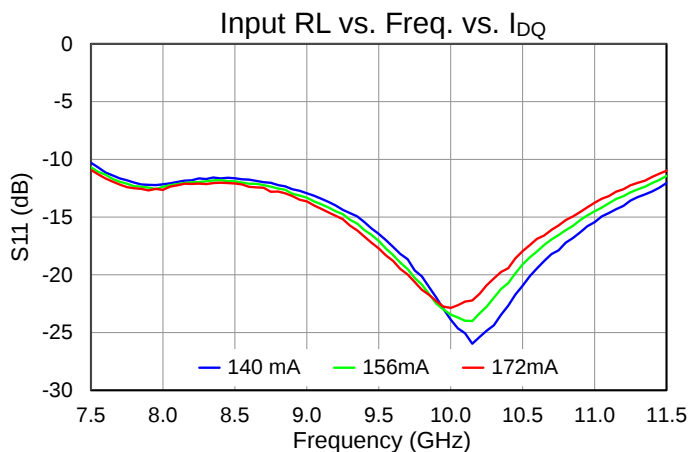
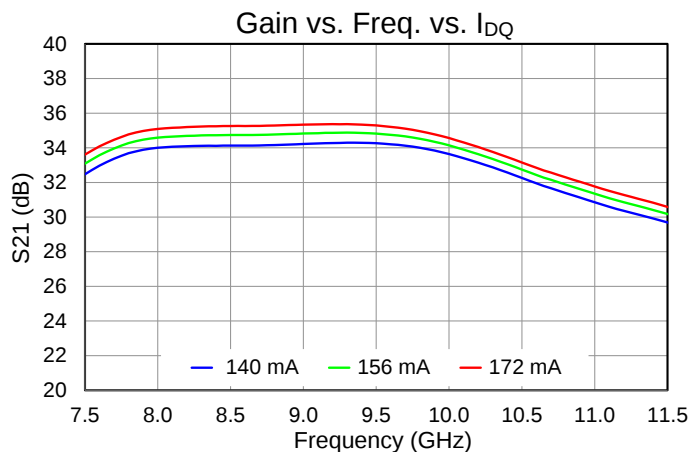
Performance Plots – Small Signal

Test conditions unless otherwise noted: T = +25 °C, VD = 6 V, IDQ = 156 mA, CW



Performance Plots – Small Signal

Test conditions unless otherwise noted: $T = +25\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, CW



Thermal and Reliability Information

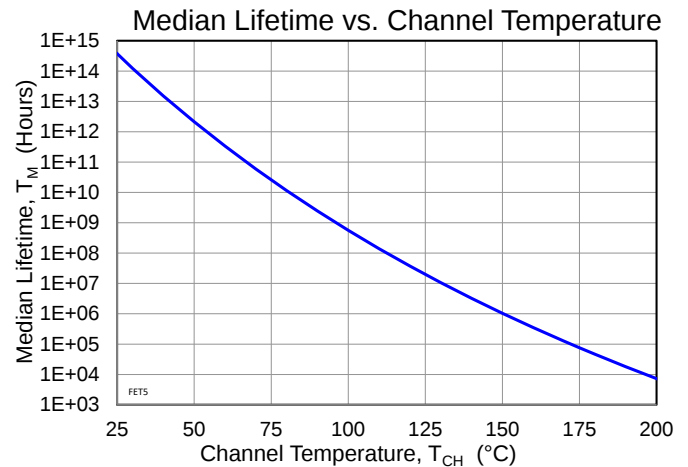
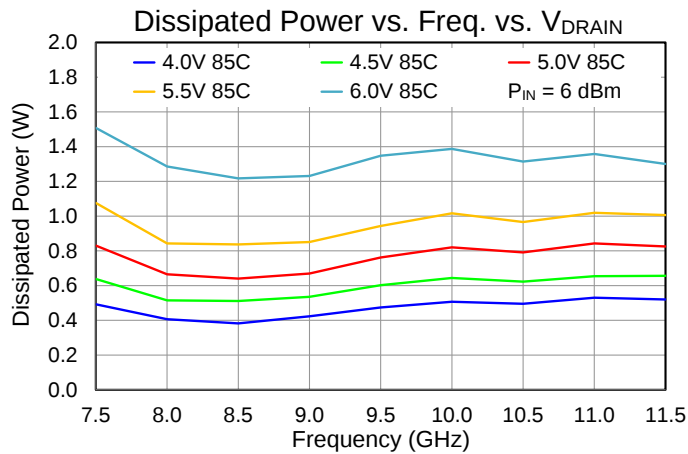
Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{base} = +85\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, DC Power, $P_{DISS} = 0.936\text{ W}$ (quiescent, no RF)	33.61	$^{\circ}\text{C/W}$
Channel Temperature, T_{CH} (Under RF) ⁽²⁾		131.7	$^{\circ}\text{C}$
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{base} = +85\text{ }^{\circ}\text{C}$, $V_D = 6\text{ V}$, $I_{DQ} = 156\text{ mA}$, $I_{D_Drive} = 415\text{ mA}$, $P_{OUT} = 30.8\text{ dBm}$, $P_{IN} = 6\text{ dBm}$, Freq. = 10.0 GHz, $P_{DISS} = 1.39\text{ W}$ (Pulse: 100us/10%)	32.97	$^{\circ}\text{C/W}$
Channel Temperature, T_{CH} (Under RF) ⁽²⁾		89.4	$^{\circ}\text{C}$

Notes:

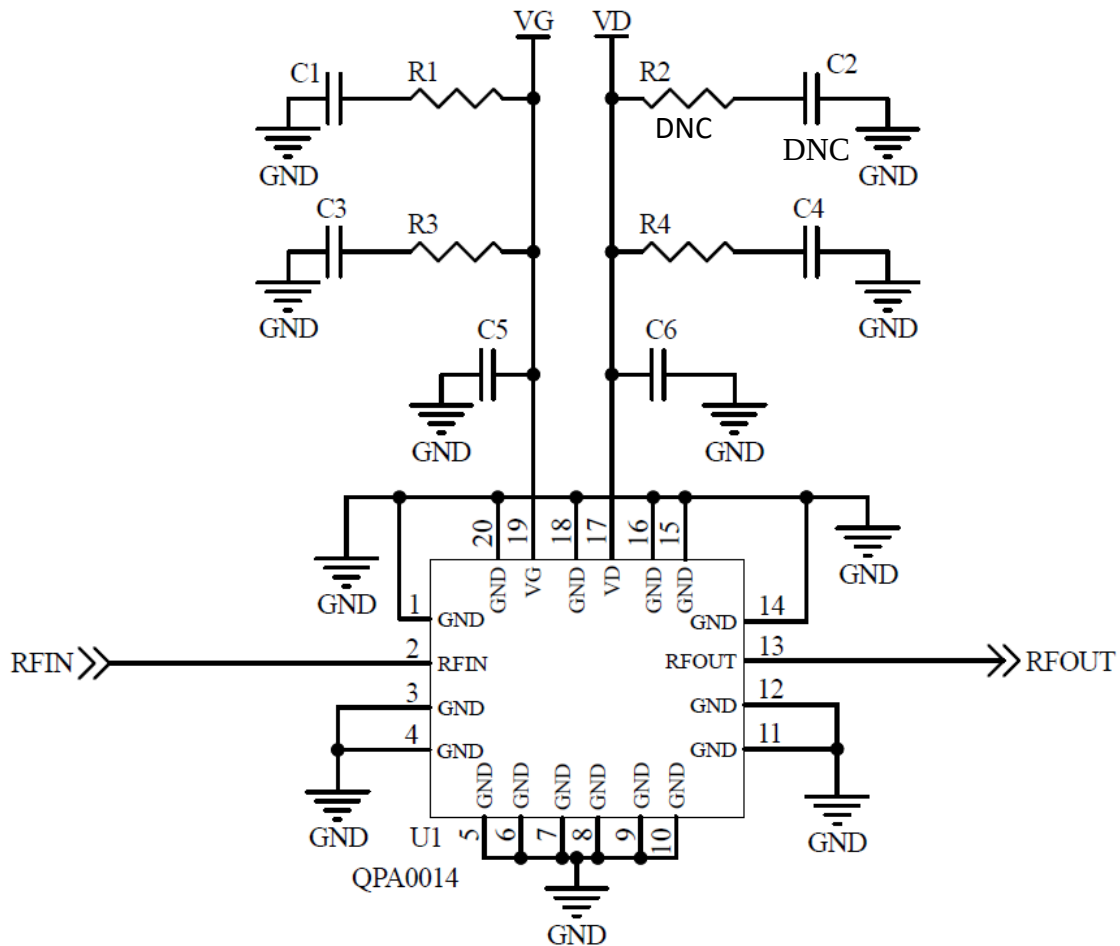
1. Thermal resistance is referenced to the back of the package.

Power Dissipation and Median Lifetime

$P_{IN} = 6\text{ dBm}$, Pulse Width = 100 us, Duty Cycle = 10%



Application Information



Bias-up Procedure

Set I_D limit to 60 mA, I_G limit to 5 mA

Apply -1.5 V to V_G

Apply +6 V to V_D ; ensure I_{DQ} is approx. 0 mA

Adjust V_G until $I_{DQ} = 156$ mA

Turn on RF supply

Bias-down Procedure

Turn off RF signal

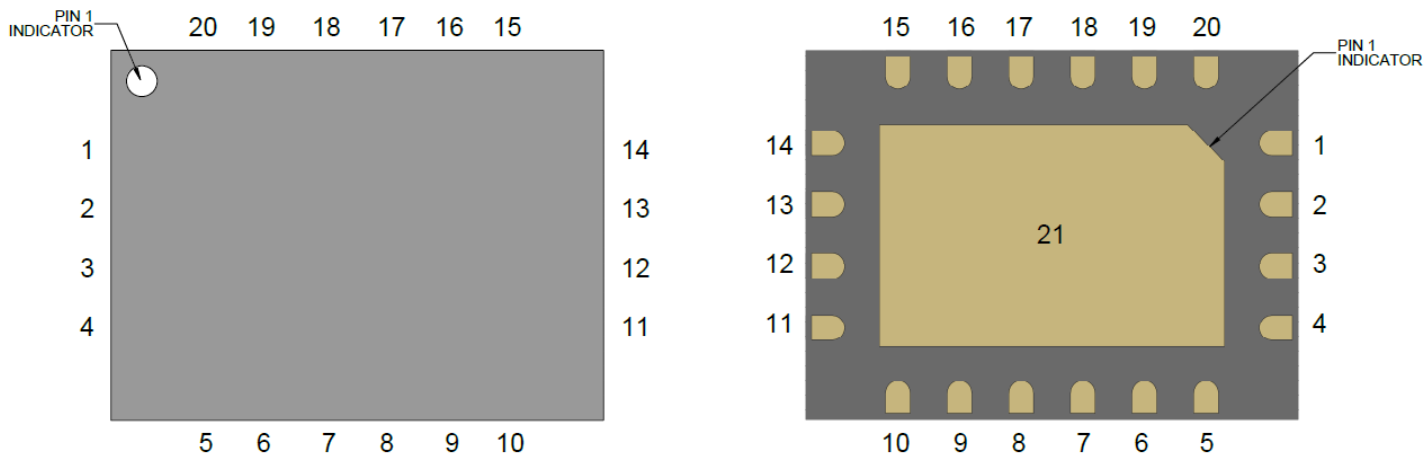
Reduce V_G to -1.5 V; ensure I_{DQ} is approx. 0 mA

Set V_D to 0 V

Turn off V_D supply

Turn off V_G supply

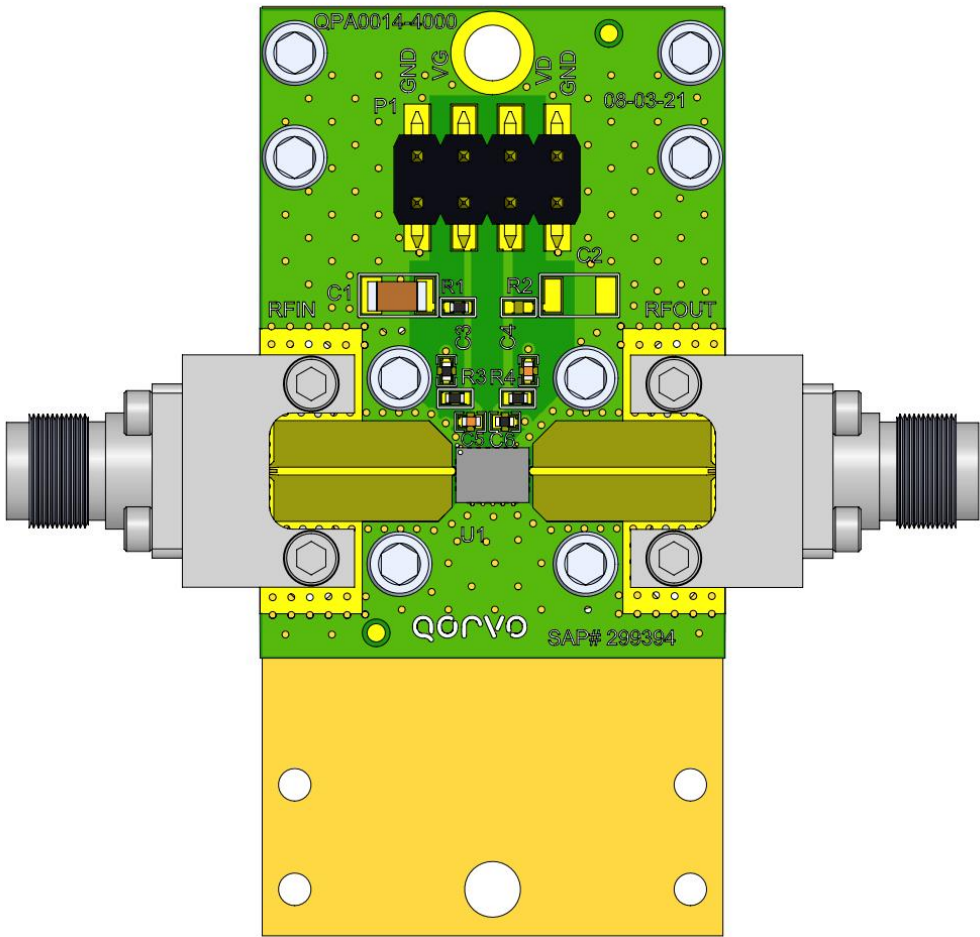
Pin Layout



Pin Description

Pin Number	Symbol	Description
1, 3-12,14-16, 17, 20	NC	No connection inside of package. Connection to PCB ground recommended
2	RF IN	RF input. 50 Ω , DC blocked
13	RF OUT	RF output. 50 Ω , DC blocked
17	VD	Drain voltage. Bypass network required; refer to page 17
19	VG	Gate voltage. Bypass network required; refer to page 17
21	GND	Center paddle ground

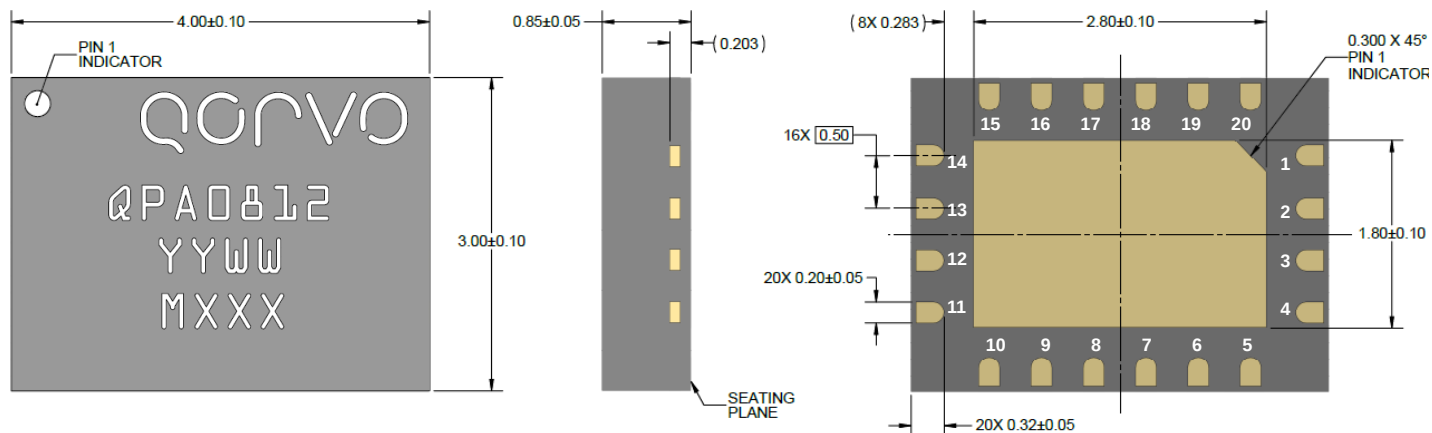
Evaluation Board



Bill of Materials

Ref. Des.	Value	Description	Manuf.	Part Number
C1	10 uF	CAP, 10uF, 20%, 50V, 20%, X5R, 1206	various	
C5,C6	1000 pF	CAP, 1000pF, 10%, 100V, X7R, 0402	various	
C3,C4	0.1 uF	CAP, 0.1uF, 10%, 50V, X7R, 0402	various	
R3,R4	0 Ω	RES, 0 OHM, JMPR, 0402	various	
R1	10 Ω	RES, 10 OHM, 5%, 0.1W, 0402	various	
J1, J2		2.92mm Female End Launch Connector	Southwest Microwave	1092-01A-5

Mechanical Information



NOTES:

Package base and leads are Ni-Au plated

Part is mold encapsulated

Part Markings:

Part Number: QPA0812

Part Assembly Year: YY

Part Assembly Week: WW

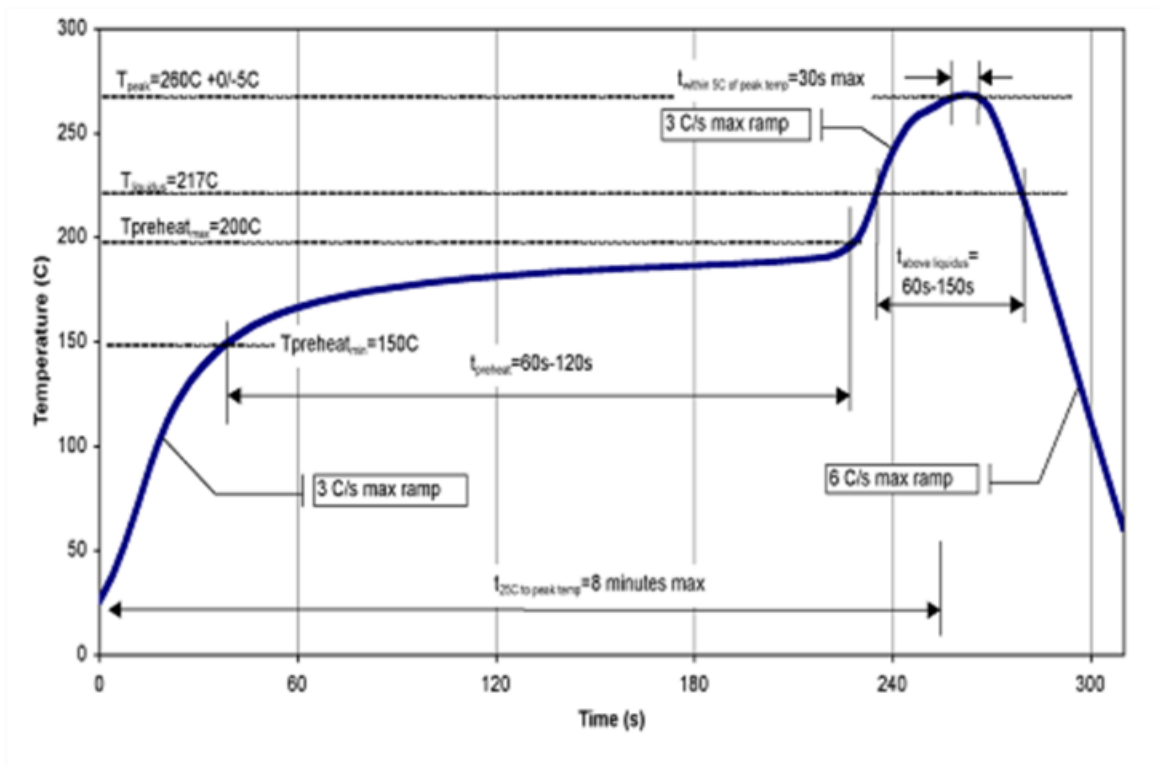
Lot Number: MXXX

Dimensions are in millimeters

Assembly Notes

Compatible with lead-free soldering processes with 260°C peak reflow temperature.

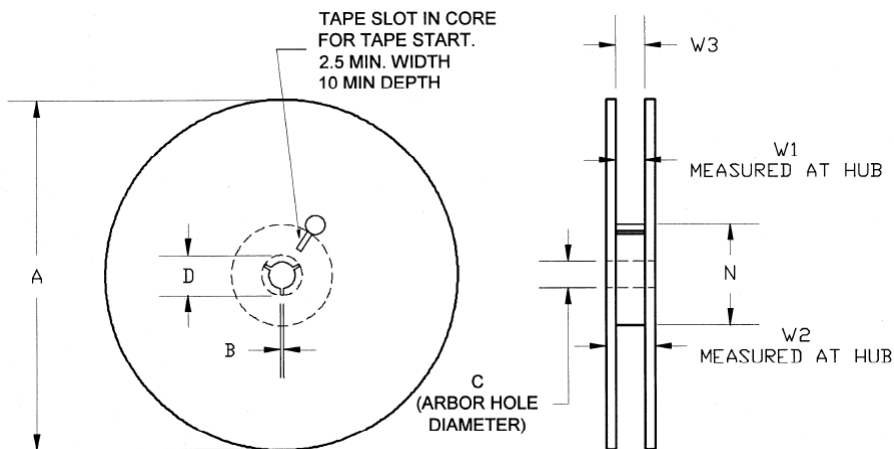
Contact plating: Ni-Au.



Recommended Soldering Temperature Profile

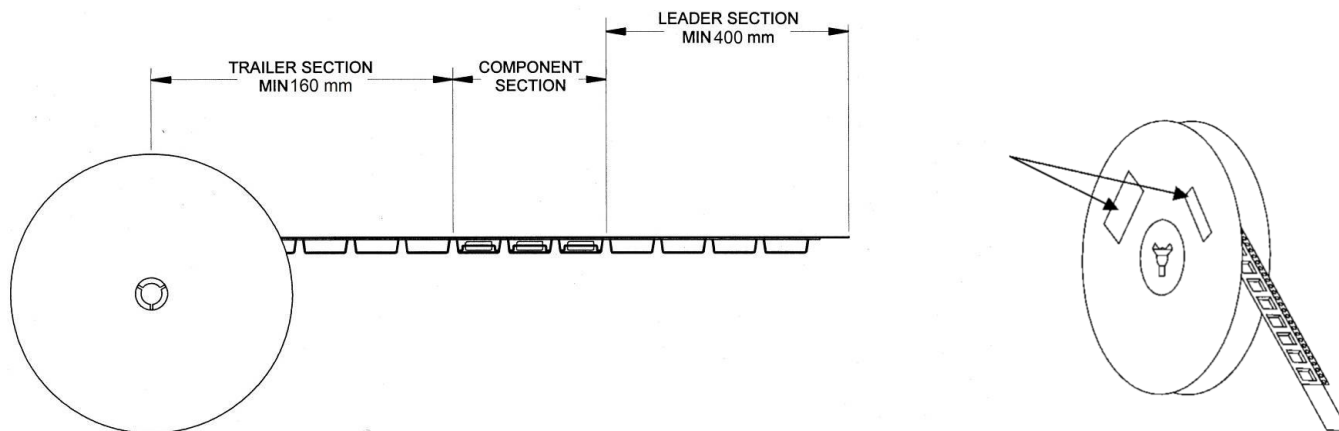
Tape and Reel Information – Reel Dimensions

Standard T/R size = 500 pieces on a 7" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	6.969	177.0
	Thickness	W2	0.724	18.4
	Space Between Flange	W1	0.488	12.4
Hub	Outer Diameter	N	2.283	58.0
	Arbor Hole Diameter	C	0.512	13.0
	Key Slit Width	B	0.079	2.0
	Key Slit Diameter	D	0.795	20.2

Tape and Reel Information – Tape Length and Label Placement



Notes:

1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	1B	ESDA / JEDEC JS-001-2014
ESD – Charged Device Model (CDM)	C3	ESDA / JEDEC JS-002-2017
MSL – Moisture Sensitivity Level	MSL3	IPC/JEDEC J-STD-020



Caution!
ESD-Sensitive Device

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- PFOS Free
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

Important Notice

The information contained herein is believed to be reliable; however, Qorvo makes no warranties regarding the information contained herein and assumes no responsibility or liability whatsoever for the use of the information contained herein. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for Qorvo products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information. **THIS INFORMATION DOES NOT CONSTITUTE A WARRANTY WITH RESPECT TO THE PRODUCTS DESCRIBED HEREIN, AND QORVO HEREBY DISCLAIMS ANY AND ALL WARRANTIES WITH RESPECT TO SUCH PRODUCTS WHETHER EXPRESS OR IMPLIED BY LAW, COURSE OF DEALING, COURSE OF PERFORMANCE, USAGE OF TRADE OR OTHERWISE, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.**

Without limiting the generality of the foregoing, Qorvo products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.

Copyright 2023 © Qorvo, Inc. | Qorvo is a registered trademark of Qorvo, Inc.